

[A] Important Dates:

S No.	RFP / Bid	Timeline
1	Stage-1 of RFP Submission - Eligibility Bid Documents	
	Mode of Submission	Offline (Address - The Chief Manager (IT Procurement), Bank of Baroda, 603, 6 th Floor, Kohinoor Square, Dadar West, Mumbai – 400028)
	Last date for Bid Submission	03:00 PM on 28 th August, 2023
	Bid Opening Date	03:30 PM on 28 th August, 2023
2	Stage-2 (Final) of RFP Submission - Technical Proposal & Commercial Bid	
	Mode of Submission	Online (GeM)
	Last date for Bid Submission	Will be informed to eligible bidders post NDA execution
	Bid Opening Date	

Addendum to following Annexure:

1. Annexure 02 – Evaluation Terms (Eligibility Criteria)
2. Section / Point 16 – The bid submission by related parties
3. New (Add) - Self Declaration from OEM (Annexure 21)

All other Terms & Conditions are same as per our RFP for Renewal of Annual Maintenance Contract of Hardware at DC, DRC, NDR and On-site Support for 3 years (Bid Number: GEM/2023/B/3592651 dated 20th June 2023).

S No	Clause in RFP	Clarifications/ Changes made
1	<p>Annexure 02 – Evaluation Terms</p> <p>A. Eligibility cum Technical Bid –</p> <p>C. Technical / Experience:</p> <p>.....</p> <p>.....</p> <p>1. The Bidder should be OEM's Authorized Partner (at least 3 OEM's out of Arista/Cisco/Dell/HPE) for providing AMC/hardware support for Data Centre devices in India at least in the last three years (from RFP date).</p> <p>.....</p> <p>.....</p>	<p>Annexure 02 – Evaluation Terms</p> <p>A. Eligibility cum Technical Bid –</p> <p>C. Technical / Experience:</p> <p>.....</p> <p>.....</p> <p>1. The Bidder should be OEM's Authorized Partner (at least 3 OEM's out of Arista/Cisco/Dell/HPE) for providing AMC/hardware support for Data Centre devices in India at least in the last three years (from RFP date).</p> <p>In case of direct participation of any OEM in the bid, the OEM has to submit a self-declaration in lieu of MAF stating that in case if they are selected for the contract then back to back agreement will be done with other OEM's for the AMC of the hardware.</p> <p>(Supporting document - Letter of confirmation from respective OEM's need to be submitted as per Annexure 10 mentioned under RFP document or self-declaration as per annexure (New annexure 21) below in the case of OEM's participated directly).</p> <p>.....</p> <p>.....</p>
2	<p>.....</p> <p>.....</p> <p>16. The bid submission by related parties:</p> <p>If related parties (as defined below) submit more than one bid then both /all bids submitted by related parties are liable to be rejected at any stage at Bank's discretion:</p> <p>a) Bids submitted by holding company and its subsidiary company;</p> <p>b) Bids submitted by two or more companies having common director/s</p>	<p>.....</p> <p>.....</p> <p>16. The bid submission by related parties:</p> <p>If related parties (as defined below) submit more than one bid then both /all bids submitted by related parties are liable to be rejected at any stage at Bank's discretion:</p> <p>a) Bids submitted by holding company and its subsidiary company;</p> <p>b) Bids submitted by two or more companies having common director/s</p>

S No	Clause in RFP	Clarifications/ Changes made
	<p>c) Bids submitted by partnership firms / LLPs having common partners</p> <p>d) Bids submitted by companies in the same group of promoters/management</p> <p>In the case of software or hardware either the Indian agent on behalf of the principal/ OEM or Principal/ OEM itself can bid but both cannot bid simultaneously for the same solution in this tender. If an agent submits bid on behalf of the Principal/ OEM, the same agent cannot submit a bid on behalf of another Principal/ OEM in this tender for the same solution.</p> <p>.....</p> <p>.....</p> <p>.....</p>	<p>c) Bids submitted by partnership firms / LLPs having common partners</p> <p>d) Bids submitted by companies in the same group of promoters/management</p> <p>In the case of software or hardware either the Indian agent on behalf of the principal/ OEM or Principal/ OEM itself can bid but both cannot bid simultaneously for the same solution in this tender. If an agent submits bid on behalf of the Principal/ OEM, the same agent cannot submit a bid on behalf of another Principal/ OEM in this tender for the same solution.</p> <p>.....</p> <p>.....</p>

Annexure 21 – Self Declaration from OEM

(To be submitted only by OEM's participating in the bid directly. This letter should be on the letterhead of the OEM / Manufacturer duly signed by an authorized signatory)

To
Chief General Manager (IT)
Bank of Baroda
Baroda Sun Tower
Bandra Kurla Complex
Bandra (E), Mumbai 400 051

Sir,

Sub: RFP for Renewal of Annual Maintenance Contract of Hardware at DC, DRC, NDR and On-site Support for 3 years.

We (Name of the OEM) who are established and reputable manufacturers / developers of having factories / offices at,and do hereby agree that back to back agreement will be signed with other OEM products which will be submitted to the Bank on award of contract to us.

We agree that in the event of any violation of non-submission of back to back agreement signed with other OEM's to the Bank within three months from date of



Request for Proposal for Renewal of Annual Maintenance Contract of Hardware at DC, DRC, NDR and On-site Support for 3 years (Bid Number: GEM/2023/B/3592651 dated 20th June 2023)

Addendum - 2 dated 18th August 2023

award of contract, then Bank is having all rights to cancel the contract without any advance notice period.

We undertake to perform the obligations as set out in the RFP in respect of such services and hereby extend our support and services for our own products and also for other OEM products which are included as part of the agreement during the contract period as per terms and conditions of the RFP.

Dated this.....by20

Yours faithfully,
Authorized Signatory
Name:
Designation:
Bidder's Corporate Name
Address
Email and Phone #